

THE NOTED DIMENSIONS APPLY AT THE INTERSECTION OF THE POST AND HOUSING POINT OF MEASUREMENT FOR PLATING THICKNESS. DIMENSIONS NOTED ARE FOR USE WITH A STENCIL FOR 1.57±0.20[.062±.008] THICK PRINTED CIRCUIT BOARD SOLDER STENCIL THICKNESS =  $0.25\pm0.03[.010\pm.001]$ .000381 [.000015] GOLD IN THE CONTACT AREA.
.00254[.000100]-.00508[.000200] MATTE TIN-LEAD ON THE SOLDER TAIL
ALL OVER .000127[.000050] NICKEL. PARTS ARE PACKAGED IN GANG OF TUBES BREAKAWAY NOTCH ANGLE CAN BE ORIENTED TO THE RIGHT (AS SHOWN)
OR TO THE LEFT .000381 [.000015] GOLD IN THE CONTACT AREA. .00254[.000100]—.00508[.000200] MATTE TIN ON THE SOLDER TAIL ALL OVER .000127[.000050] NICKEL.

AD 00

REVISIONS

DESCRIPTION

28JUN2014 NK MM

E REVISED PER ECO-14-000066

12.29 [.484] 10 5-104621-1 12.29 10 104621-1 [.484] ASSEMBLY OF POSN PART PLATING NUMBER THIS DRAWING IS A CONTROLLED DOCUMENT. ETE TE Connectivity 7-8-89 TOLERANCES UNLESS OTHERWISE SPECIFIED: HEADER ASSY, MOD II, BREAKAWAY mm [INCHES] ± -± 0.13[.005] ± -± -APPLICATION SPEC

USTOMER DRAWING

ATERIAL
GLASS FILLED THERMOPLASTIC
(THAT WILL WITHSTAND VAPOR
PHASE REFLOW),COLOR: BLACK
POST: COPPER ALLOY

SEE TABLE

SIZE CAGE CODE DRAWING NO

1 00779 **C-**104621

SCALE 4:1 SHEET OF 1 REV F

4805 (3/11)

## **Mouser Electronics**

**Authorized Distributor** 

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TE Connectivity: